## High-Speed Transimpedance Amplifier

## Description

CXA1685M is a low noise transimpedance amplifier, particularly suitable for fiber-optic system. CXA1685M is fabricated using high-speed bipolar process.

## Features

- High transimpedance: $\quad \begin{array}{ll}\text { Q } 11.2 \mathrm{k} \Omega \text { (Typ.) } \\ & \bar{Q} 10.8 \mathrm{k} \Omega \text { (Typ.) }\end{array}$
- Wide band width ( -3 dB ): Q 177MHz (Typ.)
$\bar{Q} 157 \mathrm{MHz}$ (Typ.)
- Maximum input current:

1 mA

- Low noise:
$1.7 \mathrm{pA} / \sqrt{\mathrm{Hz}}$ (Typ.)


## Applications

- SONET/SDH: 155Mb/s
- Fiber channel: $133 \mathrm{Mb} / \mathrm{s}$
- FDDI: 125Mb/s


Absolute Maximum Ratings

- Supply voltage

Vcc - Vee -0.3 to +7.0 V

- Minimum input voltage

Vin
Vee V

- Input current

IIN
-1 to +1 mA

- Output current
( $\mathrm{Q} / \overline{\mathrm{Q}}$ ) (Continuous) lo 0 to 50 mA
(Surge)
0 to 100 mA
- Storage temperature Tstg -65 to $+150^{\circ} \mathrm{C}$


## Recommended Operating Conditions

- DC power supply voltage

Vcc - Vee 4.75 to 5.46 V

- Operating ambient temperature

Ta $\quad 0$ to $+85{ }^{\circ} \mathrm{C}$

## Structure

Bipolar silicon monolithic IC

## Block Diagram and Pin Assignment



## Electrical Characteristics

- DC Electrical Characteristics (Vcc $=\mathrm{VccA}=\mathrm{GND}, \mathrm{VeeS}=\mathrm{VeeDA}=-5.46$ to $-4.75 \mathrm{~V}, \mathrm{Ta}=0$ to $\left.+85^{\circ} \mathrm{C}\right)$

| Item |  | Symbol | Test Condition | Min. | Typ. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Supply current |  | Iee | input pin left open | -15.3 | -10.0 |  | mA |
| Transimpedance | Q | ZTQ |  | 6.6 | 11.2 | 14.8 | k $\Omega$ |
|  | $\bar{Q}$ | Z $\mathrm{T}_{\mathrm{Q}}$ |  | 6.2 | 10.8 | 14.3 |  |
| Max. Input Current before clipping |  | IIN | $\mathrm{Ta}=25^{\circ} \mathrm{C}$ | +40 |  |  | $\mu \mathrm{A}$ |
| Max. Input Current |  | IIN2 |  | +1000 |  |  |  |
| Bias votlage | IN | VIN |  |  | $V E E+2.5$ |  | V |
|  | Q | VQ | input pin left open |  | Vee + 1.7 |  |  |
|  | $\overline{\mathrm{Q}}$ | V $\overline{\mathrm{Q}}$ |  |  | Vcc-2.4 |  |  |
|  | C | Vc |  |  | VEE +1.7 |  |  |
| Input capacitance |  | CIn |  |  | 1.3 |  | pF |

- AC Electrical Characteristics $\quad\left(\mathrm{Vcc}=\mathrm{VccA}=\mathrm{GND}, \mathrm{VeeS}=\mathrm{VeEDA}=-5.46\right.$ to $-4.75 \mathrm{~V}, \mathrm{Ta}=0$ to $\left.+85^{\circ} \mathrm{C}\right)$

| Item |  | Symbol | Test Condition | Min. | Typ. | Max. | Unit. |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Bandwidth (-3dB) | Q | f-3dBQ | *1 | 113 | 177 |  | MHz |
|  | $\overline{\mathrm{Q}}$ | $\mathrm{f}-3 \mathrm{~dB} \overline{\mathrm{Q}}$ |  | 109 | 157 |  |  |
| Input Current Noise Spectral Density (Mean value) |  | In | $\mathrm{fN}=1 \mathrm{kHz}$ to 156 MHz |  | 1.7 |  | $\mathrm{pA} / \sqrt{\mathrm{HZ}}$ |

*1 Assumes photodiode capacitance; CPD < 1.0pF, output load capacitance; Cout $=2.0 \mathrm{pF}$,
output load resistor; Q: $620 \Omega$ to $\mathrm{Vee}, \overline{\mathrm{Q}}: 1.3 \mathrm{k} \Omega$ to Vee

## Application Circuit



Application circuits shown are typical examples illustrating the operation of the devices. Sony cannot assume responsibility for any problems arising out of the use of these circuits or for any infringement of third party patent and other right due to same.

## Cautions for Handling

1. As the electronic breakdown level is weak, take care to handle.
2. The internal resistor of the output pin does not have the capability of drive ( $R L=10 k \Omega$ ). The terminal resistors must be connected. The resistance value is shown in application circuit.

## Typical Performance

Typical frequency characteristics $\left(\mathrm{VCC}-\mathrm{VEE}=5.0 \mathrm{~V}, \mathrm{Ta}=25^{\circ} \mathrm{C}\right)$


Typical Output Wave forms $\left(\mathrm{Vcc}-\mathrm{V}_{\mathrm{EE}}=5.0 \mathrm{~V}, \mathrm{Ta}=25^{\circ} \mathrm{C}\right)$


## Duty Cycle Distortion vs Input Current





VQ vs lin


VQ vs lin








Test Circuit $\left(\mathrm{Ta}=25^{\circ} \mathrm{C}, \mathrm{VEE}=-5.0 \mathrm{~V}\right)$


## Package Outline

 Unit: mm8PIN SOP (PLASTIC)


DETAIL B : SOLDER


DETAIL B : PALLADIUM
PACKAGE STRUCTURE

| SONY CODE | SOP-8P-L03 |
| :--- | :--- |
| EIAJ CODE | SOP008-P-0225 |
| JEDEC CODE | - |


| PACKAGE MATERIAL | EPOXY RESIN |
| :--- | :--- |
| LEAD TREATMENT | SOLDER/PALLADIUM |
| PLATING |  |$|$| LEAD MATERIAL |
| :--- |

NOTE : PALLADIUM PLATING
This product uses S-PdPPF (Sony Spec.-Palladium Pre-Plated Lead Frame).

